

Application Data Sheet

Application Information

Application number::

Filing Date::

Application Type::

Regular

Subject Matter::

Utility

Title ::

MANUFACTURING METHOD
OF SEMICONDUCTOR
DEVICE

Attorney Docket Number::

0756-7196

Total Drawing Sheets::

9

Small Entity?::

No

Applicant Information

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Japan

Given Name:: Shunpei

Middle Name::

Family Name:: YAMAZAKI

Name Suffix::

City of Residence:: Setagaya

State or Province of Residence:: Tokyo

Country of Residence:: Japan

Street of mailing address:: c/o Semiconductor Energy
Laboratory Co., Ltd., 398,
Hase

City of mailing address:: Atsugi-shi

State or Province of mailing address::	Kanagawa-ken
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	243-0036
Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Given Name::	Mitsuaki
Middle Name::	
Family Name::	OSAME
Name Suffix::	
City of Residence::	Atsugi
State or Province of Residence::	Kanagawa
Country of Residence::	Japan
Street of mailing address::	c/o Semiconductor Energy Laboratory Co., Ltd., 398, Hase
City of mailing address::	Atsugi-shi
State or Province of mailing address::	Kanagawa-ken
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	243-0036

Correspondence Information

Correspondence Customer Number ::	31780
E-Mail address::	erobinson@riplo.com

Representative Information

Representative Customer Number:: 31780

Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2002-276379	09/20/2002	Yes

Assignee Information

Assignee name:: Semiconductor Energy

Laboratory Co., Ltd.

Street of mailing address:: 398 Hase

City of mailing address:: Atsugi-shi

State or Province of mailing address:: Kangawa-ken

Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 243-0036